Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.

**.015”**



**.015”**

**Top Material: Al**

**Backside Material: Au**

**Base = .0039” X .0039”**

**Emitter = .0055” X .055”**

**Backside Potential: Collector**

**Mask Ref: CP588**

**APPROVED BY: DK DIE SIZE .015” X .015” DATE: 1/26/22**

**MFG: CENTRAL SEMI THICKNESS .006” P/N: 2N2605**

**DG 10.1.2**

#### Rev B, 7/19/02